

Technical Data Sheet

IR12-21C/TR8

Features

- Small double-end package
- Package in 8mm tape on 7" diameter reels.

Chip Infrared LED With Right Angle Lens

- Low forward voltage
- Good spectral matching to Si photo detector



Descriptions

IR12-21C/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with right angle lens. The device is spectrally matched with silicon photodiode and phototransistor.

Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

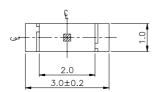
Device Selection Guide

| LED Part No. | Chip | | |
|--------------|----------|-------------|--|
| | Material | Lens Color | |
| IR | GaAlAs | Water Clear | |

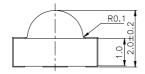
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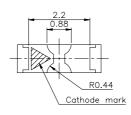
Package Dimensions

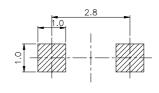






For reflow soldering (propose)





Notes: 1.All dimensions are in millimeters

2. Tolerances unless dimensions \pm 0.1 mm

Absolute Maximum Ratings (Ta=25℃)

| Parameter | Symbol | Rating | Units |
|--------------------------------|------------------|-----------|------------------------|
| Continuous Forward Current | I_{F} | 65 | mA |
| Peak Forward Current | I_{FP} | 1.0 | A |
| Reverse Voltage | V_R | 5 | V |
| Operating Temperature | T_{opr} | -25 ~ +85 | $^{\circ}\!\mathbb{C}$ |
| Storage Temperature | T_{stg} | -40 ~ +85 | \mathbb{C} |
| Soldering Temperature | T_{sol} | 260 | $^{\circ}\!\mathbb{C}$ |
| Power Dissipation at(or below) | P_d | 130 | mW |
| 25°C Free Air Temperature | | | |

Notes: *1: I_{FP} Conditions--Pulse Width $\leq 100 \mu$ s and Duty $\leq 1\%$.

*2:Soldering time ≤ 5 seconds.

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Electro-Optical Characteristics (Ta=25 $^{\circ}$ C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Units | |
|-------------------------------------|------------------------------------|--|------|------|------|---------|--|
| | Ee | I _F =20mA | 0.5 | 0.8 | | mW /sr | |
| Radiant Intensity | | $I_F = 100 mA$ Pulse Width $\leq 100 \mu\text{s}$,Duty $\leq 1\%$ | 1 | 4.0 | | | |
| Peak Wavelength | Vavelength λp $I_F = I_F$ | | 1 | 940 | | nm | |
| Spectral Bandwidth $\Delta \lambda$ | | I _F =20mA | 1 | 45 | | nm | |
| | V_{F} | I _F =20mA | | 1.2 | 1.5 | | |
| Forward Voltage | | $I_F = 100 mA$ Pulse Width $\leq 100 \mu$ s ,Duty $\leq 1\%$ | ľ | 1.4 | 1.8 | V | |
| | | $I_F=1A$ | 1 | 2.6 | 4.0 | | |
| Reverse Current | I_R | $V_R=5V$ | - | | 10 | μ A | |
| View Angle $2 \theta 1/2$ | | I _F =20mA | 1 | 160 | | deg | |

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Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.

Ambient Temperature

140 120 100 Forward Current (mA) 80 60 40 20 0 40 0 80 -25 20 60 100 Ambient Temperature (° C)

Fig.2 Spectral Distribution

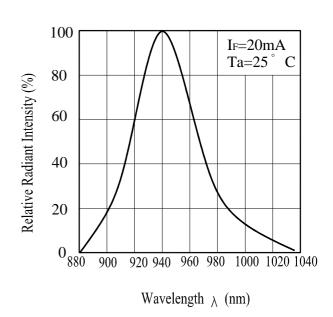


Fig.3 Peak Emission Wavelength Ambient Temperature

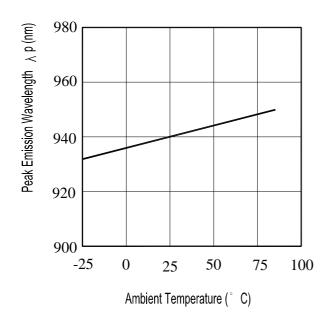
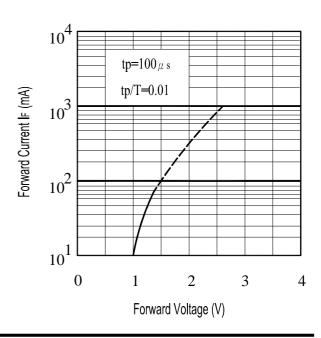


Fig.4 Forward Current vs. Forward Voltage



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Typical Electro-Optical Characteristics Curves

Fig.5 Relative Intensity vs.

Forward Current

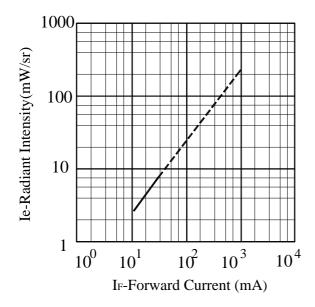


Fig.6 Relative Radiant Intensity vs.

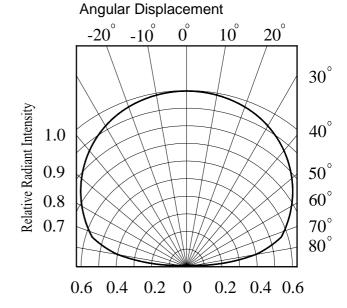


Fig.7 Relative Intensity vs.

Ambient Temperature(° C)

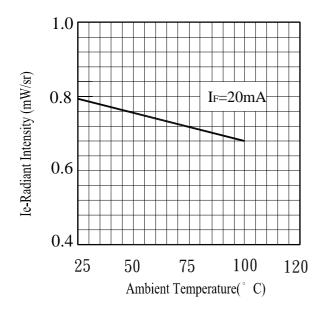
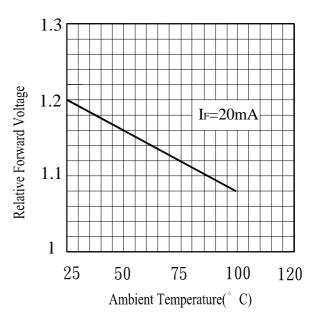


Fig.8 Forward Voltage vs.

Ambient Temperature(° C)



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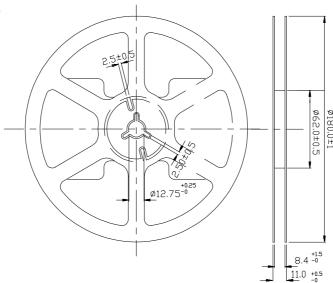
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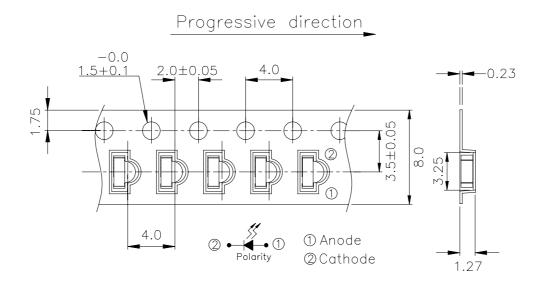
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Loaded Quantity Per Reel 2000PCS/Reel



Unit: mm

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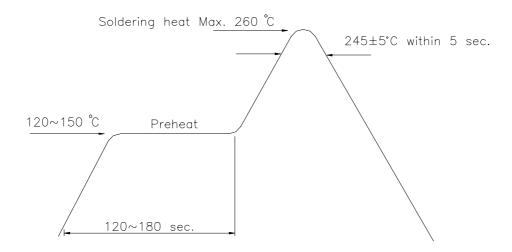
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Soldering heat reliability(DIP)

Please refer to the following figure



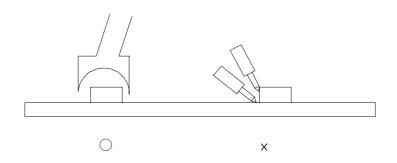
Soldering Iron

Basic spec is ≤ 5 sec when 260°C. If temperature is higher, time should be shorter (+10°C

→ -1sec). Power dissipation of Iron should be smaller than 15W , and temperature should be controllable. Surface temperature of the device should be under 230° C.

Rework

- 1.Customer must finish rework within 5 sec under 245°C.
- 2. The head of iron can not touch copper foil.
- 3.Twin-head type is preferred.



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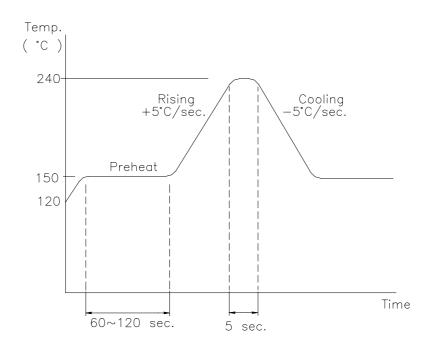
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Reflow Temp./Time



Precautions For Use

1.Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change(Burn out will happen).

2.Storage

- 2.1 The operation of temperature and R.H are $:5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, R.H.60%.
- 2.2 Once the package is opened, the products be should be used within a week. Otherwise, they should be keep in a damp proof box with desiccating anent. Considering the tape life, we suggest our customers to use our products within a year (from production date).
- 2.3 If opened more than one week in an atmosphere $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, R.H.60%., they should be treated at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 15hrs.
- 2.4 When you discover that the desiccant in the package has a pink color(normal=blue), you should treat them in the same conditions as 2.3

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Reliability Test Item And Condition

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

| NO. | Item | Test Conditions | Test Hours/ Cycles | Sample Sizes | Failure Judgement Criteria | Ac/Re |
|--------|---|---|-----------------------|-----------------|---|-------|
| 1 | REFLOW Soldering | TEMP. : 240°C± 5°C 5secs | 6mins | 22pcs | More than 90% of lead to be covered by soldering | 0/1 |
| 2 | Temperature Cycle | $H: +100^{\circ}\mathbb{C}$ $L: -40^{\circ}\mathbb{C}$ 15mins 15mins 15mins | 50Cycles | 22pcs | $I_R \ge U \times 2$ $Ee \le L \times 0.8$ | 0/1 |
| 3 | Thermal Shock | H :+100°C | 50Cycles | 22pcs | $V_F \ge U \times 1.2$ $U : Upper$ | 0/1 |
| 4 | High Temperature Storage | TEMP. ∶ +100°C | 1000hrs | 22pcs | Specification Limit | 0/1 |
| 5 | Low Temperature Storage | TEMP. : -40°C | 1000hrs | 22pcs | L: Lower Specification | 0/1 |
| 6 7 | DC Operating Life High Temperature/ High Humidity | I _F =20mA 85°C / 85% R.H | 1000hrs 1000hrs | 22pcs 22pcs | Limit | 0/1 |

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Packing Quantity Specification

- 1. 2000Pcs/1Volume , 1Volume/1Bag
- 2.10Boxes/1Carton

Label Form Specification



CPN: Customer's Production Number

P/N: Production Number

QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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